

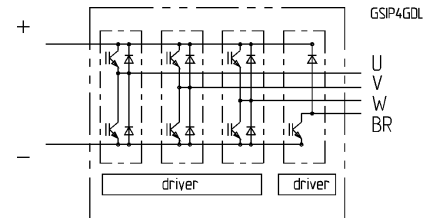
SKiiP 3-phase bridge

Absolute Maximum Ratings			
Symbol	Conditions ¹⁾	Values	Units
V _{isol} ⁴⁾	AC, 1min	4000	V
T _{op} , T _{stg}	Operating / stor. temperature	-25...+85	°C
IGBT and Diode			
V _{CES}		1700	V
V _{CC} ⁵⁾	Operating DC link voltage	1200	V
I _C	IGBT		A
T _j ³⁾	IGBT + Diode	-40...+150	°C
I _F	Diode		A
I _{FM}	Diode, t _p < 1 ms		A
I _{FSM}	Diode, T _j = 150 °C, 10ms; sin		A
I ² t (Diode)	Diode, T _j = 150 °C, 10ms	10	kAs ²
Driver			
V _{S1}	Stabilized Power Supply	18	V
V _{S2}	Non-stabilized Power Supply	30	V
f _{smax}	Switching frequency	20,0	kHz
dV/dt	Primary to secondary side	75	kV/μs

Characteristics		min.	typ.	max.	Units
IGBT					
V _{(BR)CES}	Driver without supply	≥V _{CES}	–	–	V
I _{CES}	V _{GE} = 0, T _j = 25 °C	–	1	–	mA
	V _{CE} = V _{CES} T _j = 125 °C	–	10	–	mA
V _{TO}	T _j = 125 °C	–	1,77	–	V
r _T	T _j = 125 °C	–	23,6	–	mΩ
V _{Cesat}	I _C = 140A, T _j = 125 °C	–	5,1	–	V
V _{Cesat}	I _C = 140A, T _j = 25 °C	–	3,85	–	V
E _{on} + E _{off}	V _{CC} =900/1200V, I _C =150A T _j = 125 °C	–	127/195	–	mJ
C _{CHC}	per Phase, AC side	–	0,8	–	nF
L _{CE}	Top, Bottom	–	15	–	nH
Inverse Diode ²⁾					
V _F = V _{EC}	I _F = 140A; T _j = 125 °C	–	2,60	–	V
V _F = V _{EC}	I _F = 140A; T _j = 25 °C	–	–	2,90	V
E _{on} + E _{off}	I _F = 150A; T _j = 125 °C	–	18	–	mJ
V _{TO}	T _j = 125 °C	–	0,90	–	V
r _T	T _j = 125 °C	–	8,1	–	mΩ
Thermal Characteristics					
R _{thjs} ¹⁰⁾	per IGBT	–	–	0,129	°C/W
R _{thjs} ¹⁰⁾	per Diode	–	–	0,375	°C/W
R _{thsa} ^{6,10)}	P16 heatsink; see case	–	–	0,033	°C/W
Driver					
I _{S1}	Supply current 15V-supply	340+380*f _s /f _{smax} +3,5*I _{AC} /A			mA
I _{S2}	Supply current 24V-supply	250+260*f _s /f _{smax} +2,6*I _{AC} /A			mA
t _{interlock-driver}	Interlock-time	2,3			μs
SKiiPPACK protection					
I _{TRIPSC}	Short circuit protection	188 ± 2%			A
I _{TRIPLG}	Ground fault protection	43 +/- 2%			A
T _{TRIP}	Over-temp. protection	115 ± 5%			°C
U _{DCTrip} ⁹⁾	U _{DC} -protection	1225 ± 2%			V
Mechanical Data					
M1	DC terminals, SI Units	4	–	6	Nm
M2	AC terminals, SI Units	8	–	10	Nm

SKiiPPACK®

SK integrated intelligent Power PACK
3-phase bridge with brake chopper
SKiiP
192 GDL 170 - 475 CTV ^{7,9)}
Preliminary Data
Case S5GDL



Features

- Short circuit protection, due to evaluation of current sensor signals
- Isolated power supply
- Low thermal impedance
- Optimal thermal management with integrated heatsink
- Pressure contact technology with increased power cycling capability, compact design
- Low stray inductance
- High power, small losses
- Over-temperature protection

- 1) T_{heatsink} = 25 °C, unless otherwise specified
- 2) CAL = Controlled Axial Lifetime Technology (soft and fast)
- 3) without driver
- 4) Driver Input to DC Link/ AC Output to heatsink
- 5) with Semikron-DC link (low inductance)
- 6) other heatsinks on request
- 7) C - Integrated current sensors
T - Temperature protection
V - 15 V or 24 V power supply
- 9) options available for driver:
U - DC link voltage sense
F – Fiber optic connector
- 10) "s" referenced to temperature sensor

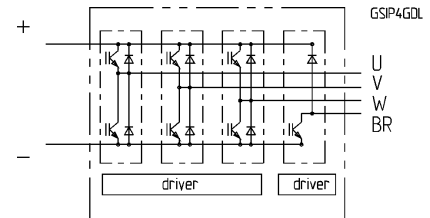
SKiiP Brake-chopper

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f _{smax}	Switching frequency	20,0	kHz
dV/dt	Primary to secondary side	50	kV/μs

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I _{S2}	Supply current 24V-supply	67+10*f _s /f _{smax} +0*I _{AC} /A			mA
t _{interlock-driver}	Interlock-time	2,3			μs
SKiiPPACK protection					
I _{TRIPSC}	Short circuit protection	VCEsat-protection ± 2%			A
I _{TRIPLG}	Ground fault protection	-			A
T _{TRIP}	Over-temp. protection	115 ± 5%			°C
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